



Leaded Inductors

Series/Type: B82145A

The following products presented in this data sheet are being withdrawn.

Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B82145A1685J000		2025-08-22	2026-08-31	2027-02-28
B82145A1684J000		2025-08-22	2026-08-31	2027-02-28
B82145A1475J000		2025-08-22	2026-08-31	2027-02-28



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B82145A1474J000		2025-08-22	2026-08-31	2027-02-28
B82145A1335J000		2025-08-22	2026-08-31	2027-02-28
B82145A1334J000		2025-08-22	2026-08-31	2027-02-28
B82145A1225J000		2025-08-22	2026-08-31	2027-02-28
B82145A1224J000		2025-08-22	2026-08-31	2027-02-28
B82145A1155J000		2025-08-22	2026-08-31	2027-02-28
B82145A1154J000		2025-08-22	2026-08-31	2027-02-28
B82145A1106J000		2025-08-22	2026-08-31	2027-02-28
B82145A1105J000		2025-08-22	2026-08-31	2027-02-28
B82145A1104J000		2025-08-22	2026-08-31	2027-02-28

Please contact your nearest TDK sales office if you need support in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.tdk-electronics.tdk.com/sales.

HLBC choke (High-Current Large Bobbin Core)
Rated inductance 100 ... 10 000 μ H
Rated current 110 ... 860 mA
Construction

- Large ferrite drum core
- Winding: enamel copper wire
- Flame-retardant lacquer coating

Features

- High rated current at high inductance ratings
- Radial leads in bulk on request (B82145C)
- Suitable for wave soldering
- RoHS-compatible

Applications

- Decoupling
- Interference suppression
- For energy-saving lamps and entertainment electronics

Terminals

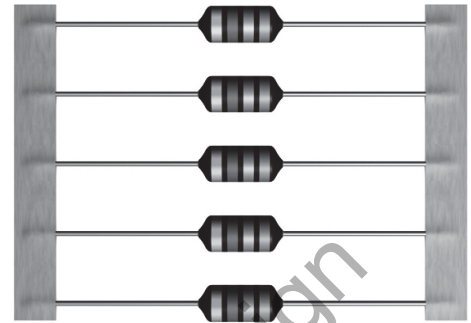
- Central axial leads (B82145A)
- Radially bent to 5mm lead spacing (B82145C)
- Base material CuAg0.1
- Electroplated with nickel and pure tin

Marking

Inductance indicated by color bands to IEC 60062

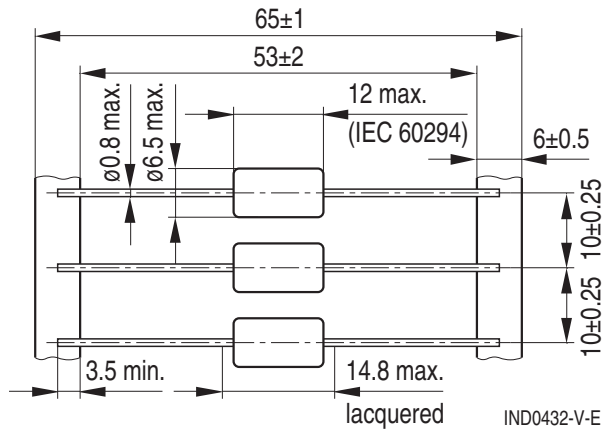
Delivery mode and packing unit

- Taped and reeled
Packing unit: 1250 pcs./reel
- Bulk packaging for radially bent
Packing unit: 200 pcs./polyethylene bag



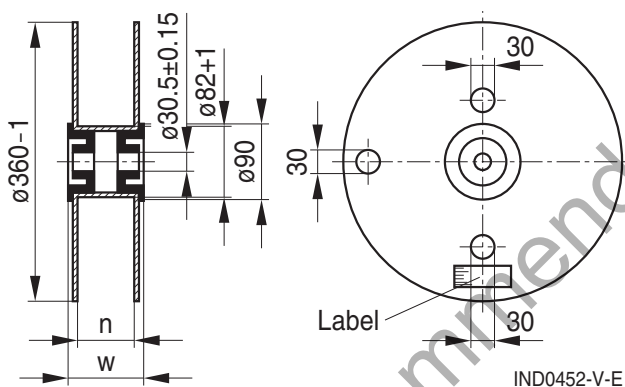
HLBC series, 6.5 x 12 (mm)

Dimensional drawing



Dimensions in mm
Minimum lead spacing 15 mm

Packing



Dimensions in mm

n (mm): 72 +1
w (mm): 84 max

Technical data and measuring conditions

Rated inductance L_R	Measured with LCR meter Agilent 4284A or impedance analyzer Agilent 4294A Measuring frequency: $100 \mu\text{H} < L_R \leq 4700 \mu\text{H} = 100 \text{ kHz}$ $L_R > 4700 \mu\text{H} = 10 \text{ kHz}$ Measuring current: $\leq 1 \text{ mA}$ Measuring temperature: $+20 \text{ }^\circ\text{C}$
Q factor $Q_{\min}$	Measured with precision impedance analyzer Agilent 4294A, $+20 \text{ }^\circ\text{C}$
Rated temperature T_R	$+40 \text{ }^\circ\text{C}$
Rated current I_R	Maximum permissible DC current at rated temperature
Inductance decrease $\Delta L/L_0$	$\leq 10\%$ (referred to initial value) at I_R , $+20 \text{ }^\circ\text{C}$
DC resistance $R_{\max}$	Measured at $+20 \text{ }^\circ\text{C}$
Resonance frequency $f_{\text{res},\min}$	Measured with Agilent 4294A or 8753ES, $+20 \text{ }^\circ\text{C}$
Solderability (lead-free)	Sn95.5Ag3.8Cu0.7: $+(245 \pm 5) \text{ }^\circ\text{C}$, $(3 \pm 0.3) \text{ s}$ Wetting of soldering area $\geq 90\%$ (to IEC 60068-2-20, test Ta)
Resistance to soldering heat	$+(260 \pm 5) \text{ }^\circ\text{C}$, 10 s (to IEC 60068-2-20, test Tb)
Tensile strength of leads	$\geq 20 \text{ N}$ (to IEC 60068-2-21, test Ua)
Climatic category	55/125/56 (to IEC 60068-1)
Storage conditions	Mounted: $-55 \text{ }^\circ\text{C} \dots +125 \text{ }^\circ\text{C}$ Packaged: $-25 \text{ }^\circ\text{C} \dots +40 \text{ }^\circ\text{C}$, $\leq 75\% \text{ RH}$
Weight	Approx. 1.3 g

⚠ Mounting information

When bending the leads, take care that the start-of-winding areas at the face ends (protected by glue and lacquer) are not subjected to any mechanical stress.

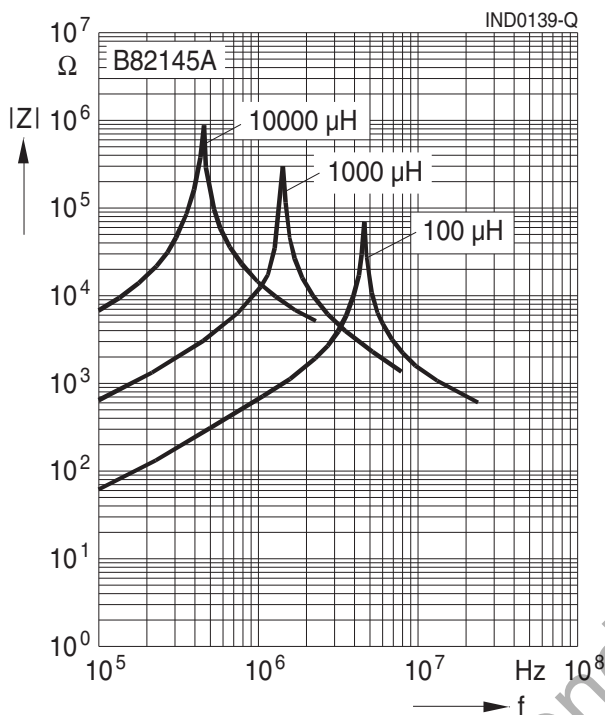
Characteristics and ordering codes

L_R μH	Tolerance ¹⁾	$Q_{\min}$	f_Q MHz	I_R mA	$R_{\max}$ Ω	$f_{\text{res,min}}$ MHz	Ordering code
100	$\pm 5\% \triangle J$	50	0.796	860	0.70	3.5	B82145A1104J000
150		40	0.796	770	0.90	3.0	B82145A1154J000
220		30	0.796	690	1.10	2.5	B82145A1224J000
330		30	0.796	630	1.30	2.1	B82145A1334J000
470		30	0.796	510	1.90	1.8	B82145A1474J000
680		20	0.796	440	2.50	1.5	B82145A1684J000
1000		60	0.252	370	3.60	1.3	B82145A1105J000
1500		60	0.252	300	5.40	1.0	B82145A1155J000
2200		60	0.252	250	8.00	0.8	B82145A1225J000
3300		60	0.252	200	12.5	0.6	B82145A1335J000
4700		60	0.252	170	18.0	0.5	B82145A1475J000
6800		60	0.252	130	28.5	0.4	B82145A1685J000
10000		50	0.0796	110	35.0	0.35	B82145A1106J000

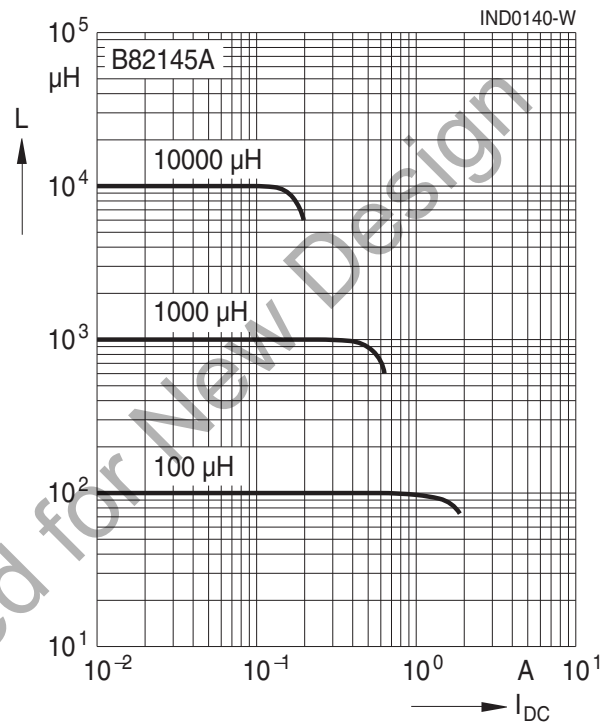
HLBC chokes with diameter 7.5 and 8.5 mm for even higher rated currents available on request.
HLBC chokes with temperature range up to +140 °C available on request.

1) Closer tolerances on request.

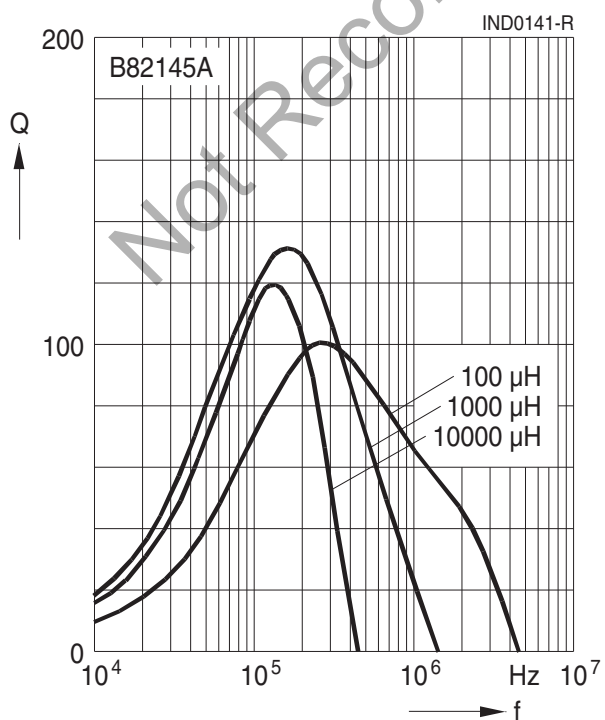
Impedance $|Z|$ versus frequency f
measured with impedance analyzer Agilent 4294A or S-parameter network analyzer Agilent 8753ES, typical values at +20 °C



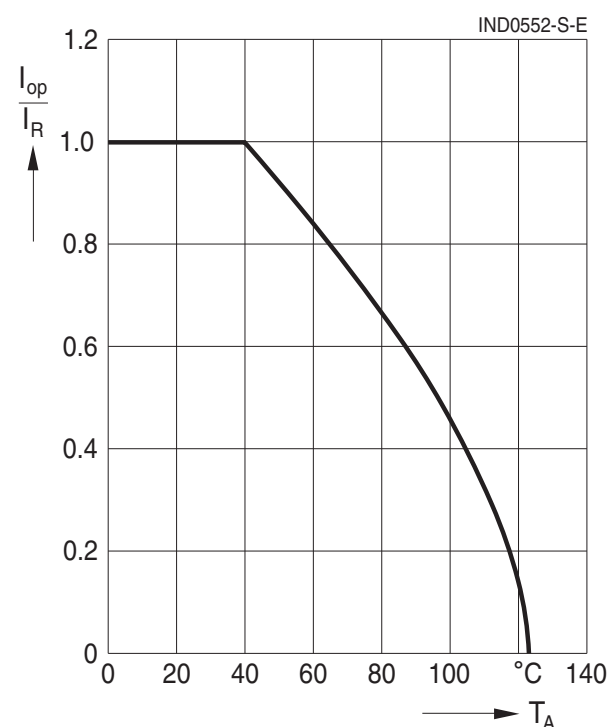
Inductance L versus DC load current I_{DC}
measured with LCR meter Agilent 4284A, typical values at +20 °C



Q factor versus frequency f
measured with impedance analyzer Agilent 4294A, typical values at +20 °C



Current derating I_{op}/I_R versus ambient temperature T_A
(rated temperature $T_R = +40$ °C)



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
 - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
 - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pins only. Temperatures specified in relation to reflow soldering can also refer to the pins or terminals for products with larger thermal mass, as in such cases, the temperature difference to the top of the component is too big (e.g., high proportion of core within the component).
- If the components are to be washed or varnished it is necessary to check whether the washing or varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing or varnish agent residues to have a negative effect in the long-term on wire insulation.
 Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
 - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting, sealing, or varnishing materials used attack or destroy the wire, wire insulation, plastics or glue.
 - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
 - Many coating materials have a negative effect (chemically and mechanically) on the winding wires, insulation materials and connecting points. Customers are always obliged to determine whether and to what extent their coating materials influence the component. Customers are responsible and bear all risk for the use of the coating material. TDK Electronics does not assume any liability for failures of our components that are caused by the coating material.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
 - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
 - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
 - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.** Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

Important notes

The following applies to all products named in this publication:

- 1 Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2 We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3 **The warnings, cautions and product-specific notes must be observed.**
- 4 In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5 We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.
We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- 6 Unless otherwise agreed in individual contracts, **all orders are subject to our General Terms and Conditions of Supply**.
- 7 **Our manufacturing sites serving the automotive business apply the IATF 16949 standard**. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System**. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.

Important notes

- 8 The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, FilterCap, FormFit, InsuGate, LeaXield, MediPlas, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PiezoBrush, PlasmaBrush, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SurfIND, ThermoFuse, WindCap, XieldCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

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